

AM/DM37x Power Estimation Spreadsheet

ARM MPU Applications

ABSTRACT

This article has been contributed to the TI Developer Wiki. To see the most recently updated version or to contribute, visit this topic at:

http://processors.wiki.ti.com/index.php/AM/DM37x_Power_Estimation_Spreadsheet

This article discusses the power consumption of the Texas Instruments AM/DM37x high-performance applications and multimedia processor. Power consumption on the AM/DM37x device is highly application-dependent, therefore, a spreadsheet is provided to model power consumption for a user's application and to present some measured scenarios. Version 1.x of the spreadsheet supports configurability of device core modules such as the ARM® Cortex™-A8, DSP and most peripherals. The data in the accompanying spreadsheet represents measurements and estimates for strong units, which are indicative of the expected maximums of power consumption for production units. Thus, the spreadsheet values can be used for board thermal analysis and power supply design as a maximum long-term average. The spreadsheet does not represent power savings possible with AM/DM37x SmartReflex™ features such as dynamic power switching (DPS) or adaptive voltage scaling (AVS).

The data presented in the Version 1.x power estimation spreadsheet are based on measurements performed on DM3730 revision 1.0 silicon, as well as estimates.

The spreadsheet discussed in this application report can be downloaded from <http://www.ti.com/lit/zip/SPRABE5>.

ARM is a registered trademark of ARM Limited.

Cortex is a trademark of ARM Limited.

SmartReflex is a trademark of Texas Instruments, Inc.

All trademarks are property of their respective owners.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2019, Texas Instruments Incorporated